3.0 GHz DIVIDE BY 4 PRESCALER UPB1510GV

FEATURES

- HIGH FREQUENCY OPERATION TO 3 GHz
- FIXED DIVIDE RATIO: + 4
- LOW CURRENT CONSUMPTION: 15 mA at 5 V
- SMALL PACKAGE: 8 PIN SSOP
- AVAILABLE IN TAPE AND REEL

TEST CIRCUIT



DESCRIPTION

NEC's UPB1510GV is a Silicon RFIC digital prescaler manufactured with the NESAT[™] IV silicon bipolar process. It features frequency response to 3 GHz, a divide-by-four ratio, and operates on a 5 volt supply while drawing only 15 mA. The device is housed in a small 8 pin SSOP package that contributes to system miniaturization. The low power consumption and wide frequency operation makes the device well suited for use in a PLL synthesizer for UHF/VHF TV and DBS tuner applications.

ELECTRICAL CHARACTERISTICS (TA = -40 to +85°C, Vcc = 4.5 to 5.5 V, Zs = ZL = 50 Ω)

PART NUMBER PACKAGE OUTLINE			UPB1510GV S08		
SYMBOLS	PARAMETERS AND CONDITIONS	UNITS	MIN	ТҮР	MAX
lcc	Circuit Current, No Input Signal	mA	10.5	14	17
fin (u)1	Upper Limit Operating Frequency 1, PIN = -10 to +6 dBm	GHz	3.0		
fin (u)2	Upper Limit Operating Frequency 2, PIN = -15 to +6 dBm	GHz	2.7		
fin (L)	Lower Limit Operating Frequency, PIN = -15 to +6 dBm	GHz			0.5
PIN1	Input Power 1, fin = 2.7 to 3.0 GHz	dBm	-10		+6
PIN2	Input Power 2, fin = 1.0 to 2.7 GHz	dBm	-15		+6
Роит	Output Power, PIN = 0 dBm, fIN = 2.0 GHz	dBm	-12	-7	

ABSOLUTE MAXIMUM RATINGS¹ (TA = 25°C)

SYMBOLS	PARAMETERS	UNITS	RATINGS
Vcc	Supply Voltage	V	6.0
VIN	Input Voltage	V	6.0
PD	Total Power Dissipation ²	mW	250
Та	Operating Ambient Temp.	°C	-40 to +85
Tstg	Storage Temperature	°C	-55 to +150

Notes:

1. Operation in excess of any one of these parameters may result in permanent damage.

 Mounted on a double-sided copper clad 50x50x1.6 mm epoxy glass PWB (T_A = +85°C).

INTERNAL BLOCK DIAGRAM



SYSTEM APPLICATION EXAMPLE

RF UNIT BLOCK OF DBS TUNER



PIN DESCRIPTIONS

Pin No.	Symbol	Applied Voltage	Description	
1	VCC	4.5 to 5.5 1000 pF).	Power supply pin. This pin must be decoupled with a bypass capacitor (e.g.	
2	IN	-	Signal input pin. This pin should be coupled to source with a capacitor (e.g. 1000 pF).	
3	ĪN	_	Signal input bypass pin. This pin must be equipped with a bypass capacitor (e.g. 1000 pF) to ground.	
4	GND	0	Ground pin. Ground pattern on the board should be formed as wide as possible to minimize ground impedance.	
5	GND	0		
6	NC	_	No connection, this pin should be left open.	
7	OUT	-	Divided frequency output pin. This pin is designed as an emitter follower output, and should be coupled to the load with a capacitor (e.g. 1000 pF).	
8	NC	_	No connection, this pin should be left open.	

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	UNITS	MIN	ТҮР	MAX
Vcc	Supply Voltage	V	4.5	5.0	5.5
Та	Operating Ambient Temp.	°C	-40	+25	+85

TYPICAL PERFORMANCE CURVES (TA = +25°C unless otherwise noted)



INPUT POWER vs. INPUT FREQUENCY and TEMPERATURE



OUTPUT POWER vs. INPUT FREQUENCY and VOLTAGE



INPUT POWER vs. INPUT FREQUENCY and VOLTAGE



OUTPUT POWER vs. INPUT FREQUENCY and VOLTAGE



OUTPUT POWER vs. INPUT FREQUENCY and VOLTAGE



TYPICAL PERFORMANCE CURVES (TA = +25°C unless otherwise noted)



TYPICAL SCATTERING PARAMETERS (TA = 25°C)





\overline{V}_1	: 500	MHz
∑ 2	: 1000	MHz
∇ 3	: 2000	MHz
⊽ 4	: 3000	MHz

FREQUENCY MHz	S11 (Ω)
500	37.1 - j207.8
1000	14.2 - j105.1
2000	7.9 - j35.8
3000	27.1 - j27.5

TYPICAL SCATTERING PARAMETERS (TA = 25°C)

\$22 vs. OUTPUT FREQUENCY \$\$Vcc = 5.0 V, fin = 500 MHz, TA = 25°C, Zo = 50 Ω



START 0.125000000 GHz STOP 0.750000000 GHz

FREQUENCY MHz	S22 (Ω)
125	55.5 + j6.7
250	53.7 + j30.4
500	55.0 + j60.3
750	60.9 + j104.8

S22 vs. OUTPUT FREQUENCY $Vcc = 5.0 \text{ V}, \text{ fin} = 3 \text{ GHz}, \text{ Ta} = 25^{\circ}\text{C}, \text{ Zo} = 50 \Omega$



FREQUENCY MHz	S22 (Ω)
125	28.5 + j11.5
250	27.6 + j23.6
500	20.5 + j50.7
750	15.6 + j98.2

OUTLINE DIMENSIONS (Units in mm)

PACKAGE OUTLINE S08





PIN CONNECTIONS				
1. Vcc	5. GND			
2. IN	6. NC			
3. IN	7. OUT			
4. GND	8. NC			

ORDERING INFORMATION

PART NUMBER	QUANTITY
UPB1510GV-E1-A	1000/Reel

Note:

1. Embossed tape 8 mm wide.

Pin 1 is in the tape pull-out direction.

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Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

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